

FIRST EMBODIMENT

FIG. 1

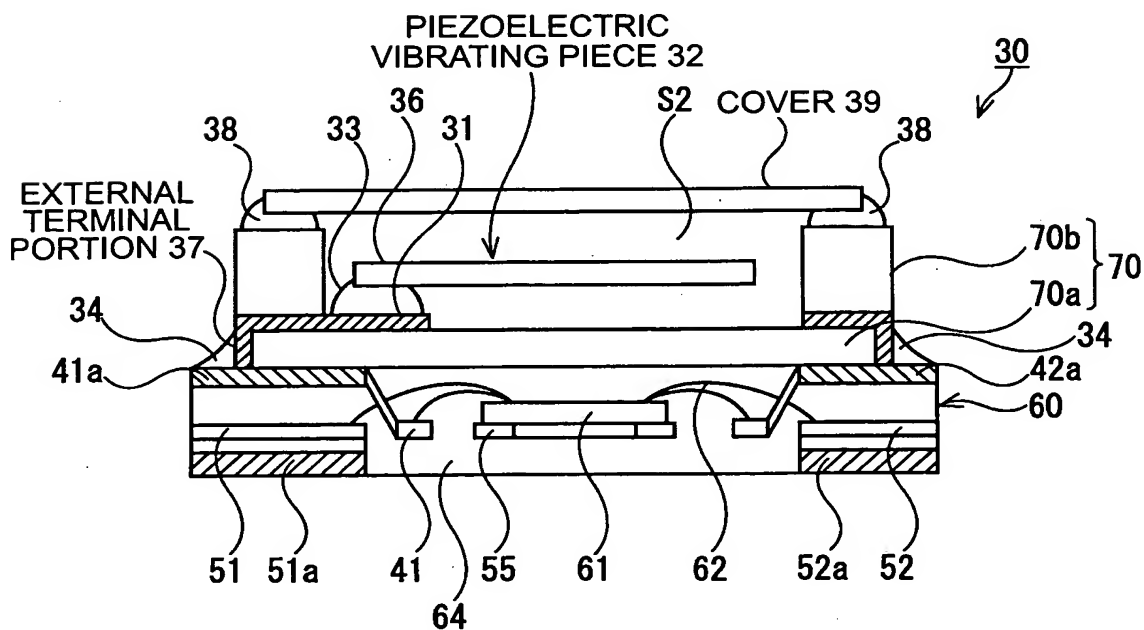
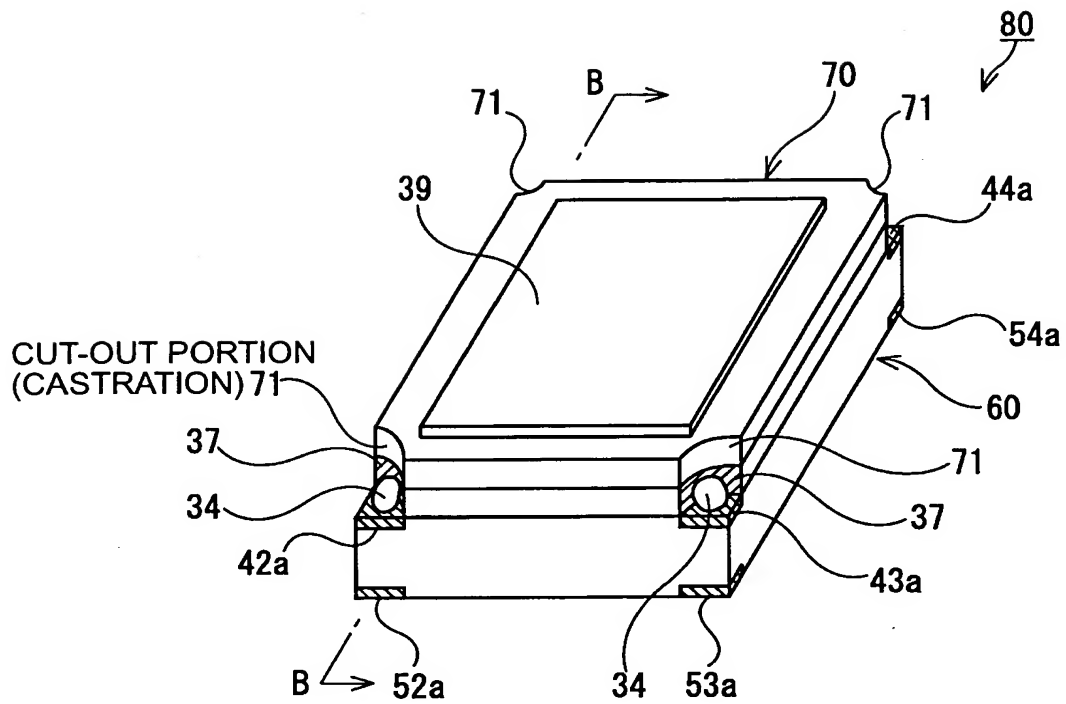


FIG. 2



SECOND EMBODIMENT

FIG. 3

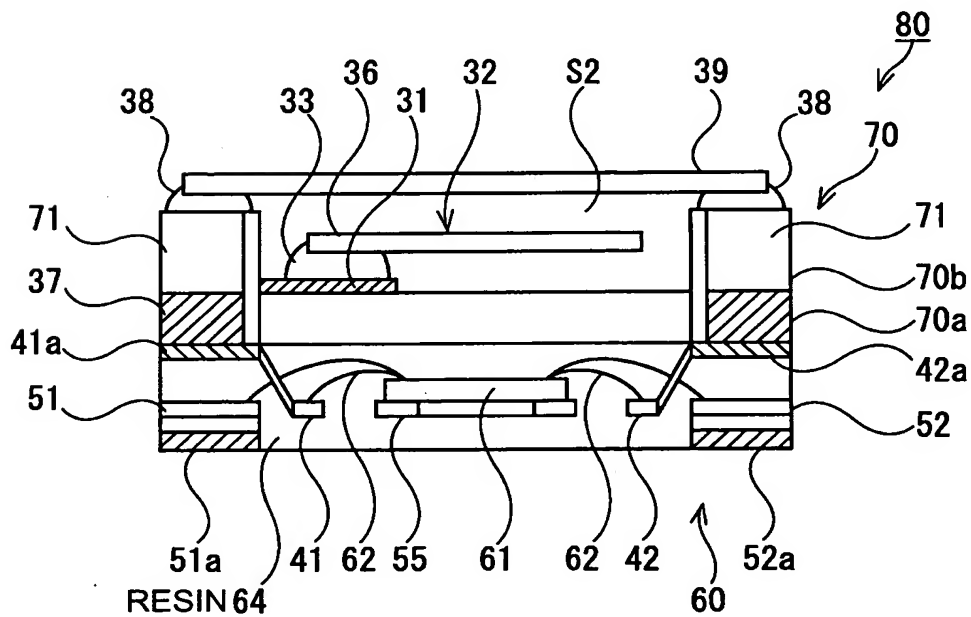


FIG. 4

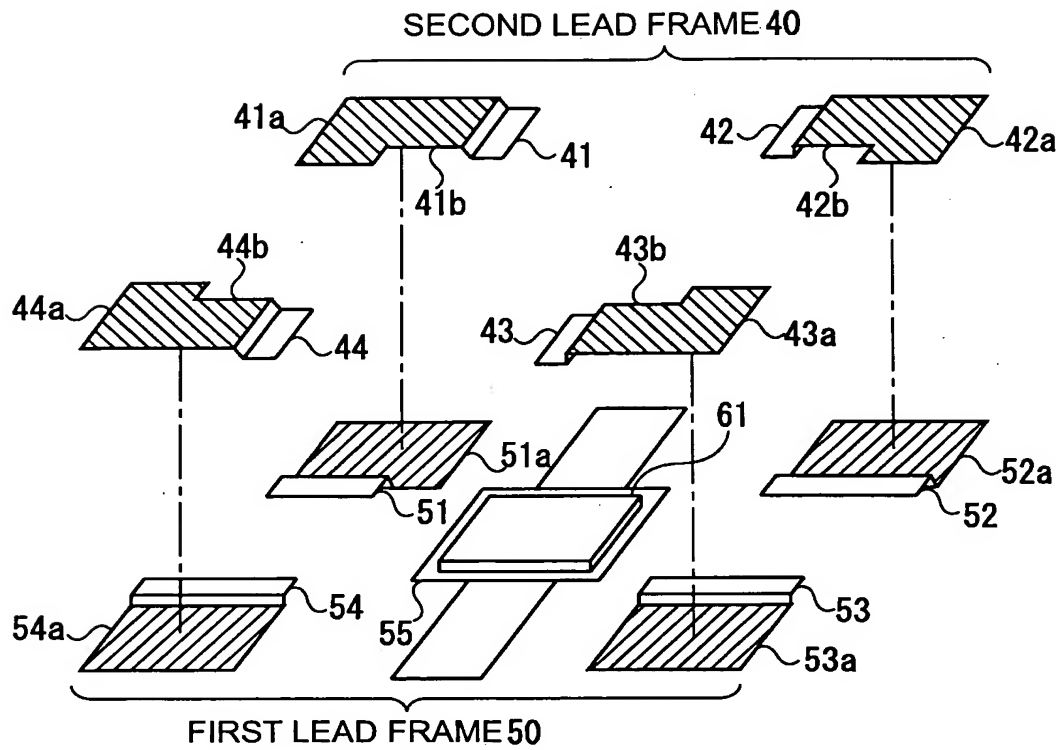


FIG. 5

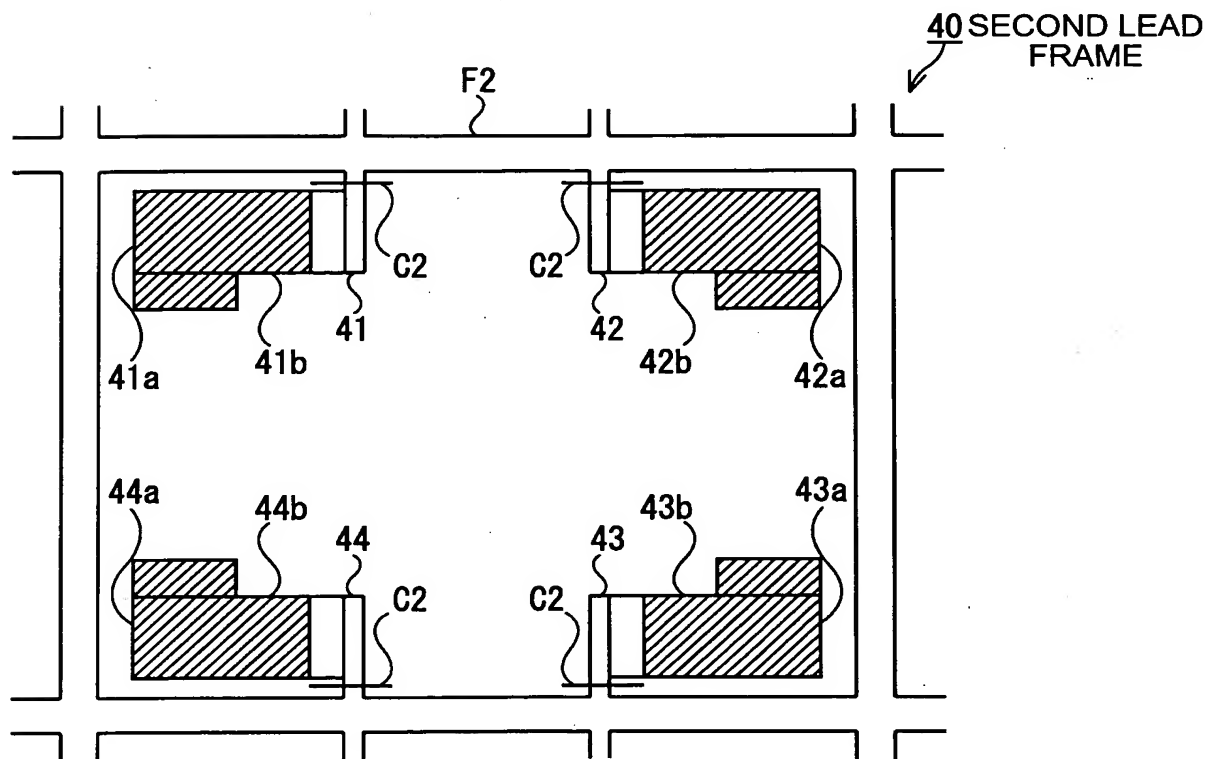


FIG. 6

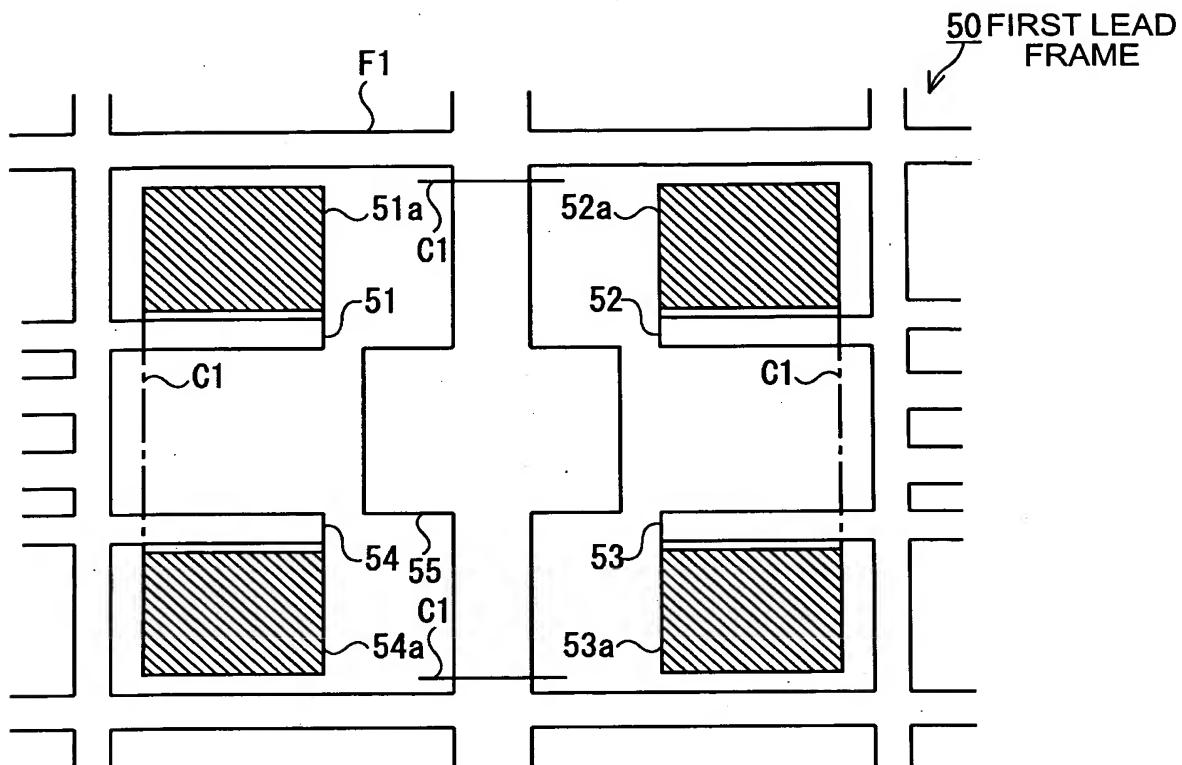


FIG. 7

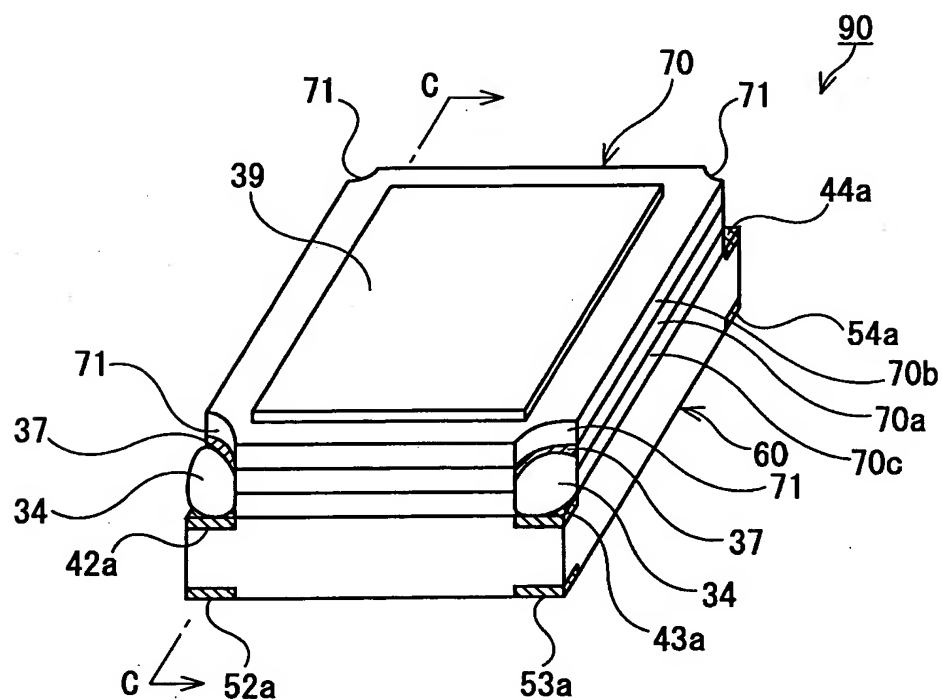


FIG. 8

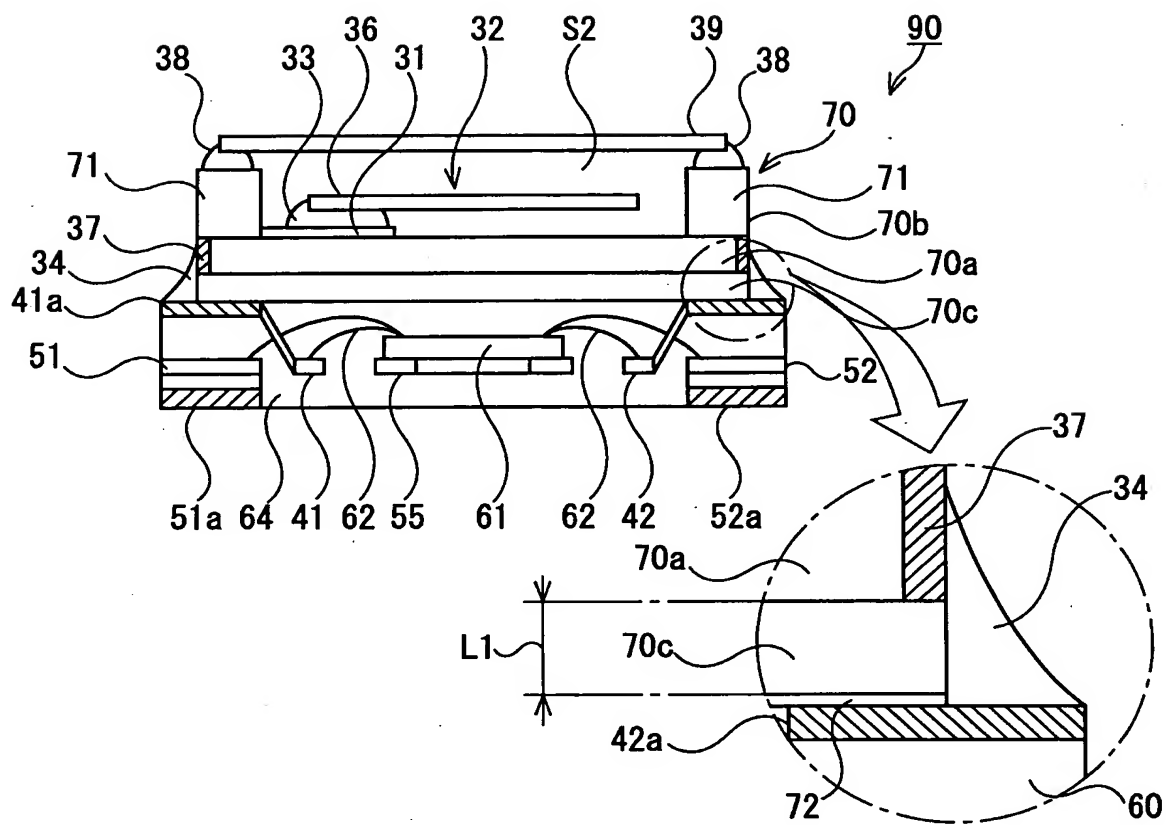


FIG. 9

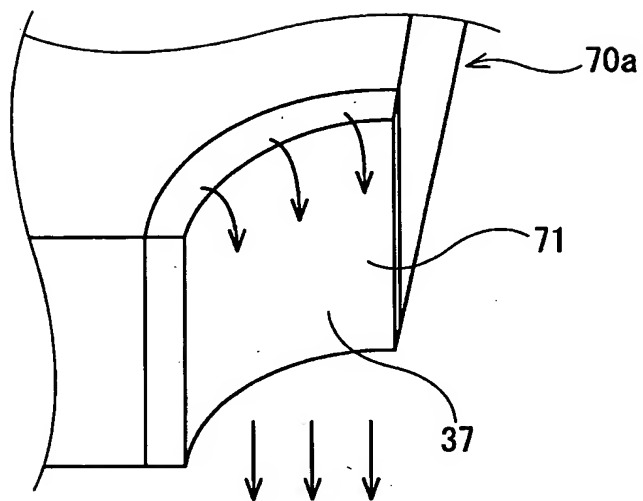


FIG. 10A

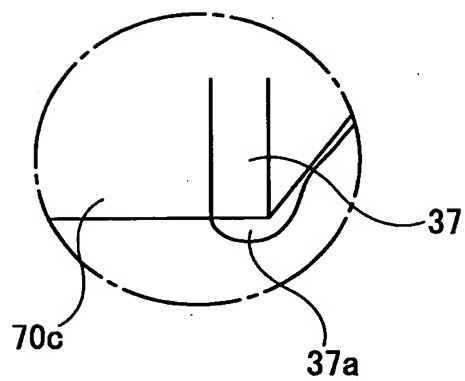


FIG. 10B

FIG. 11A

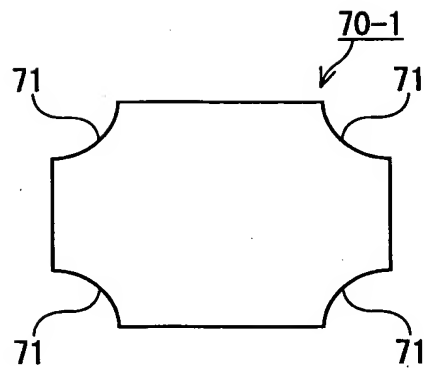


FIG. 11B

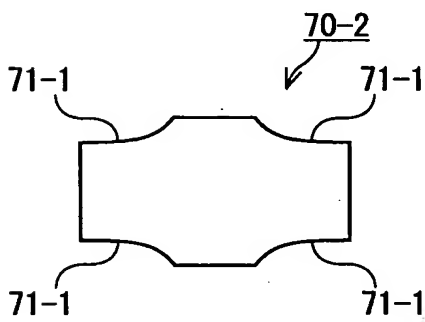


FIG. 11C

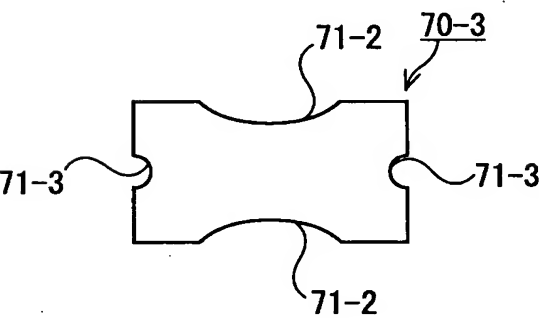
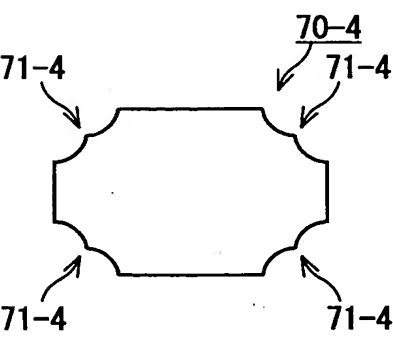


FIG. 11D



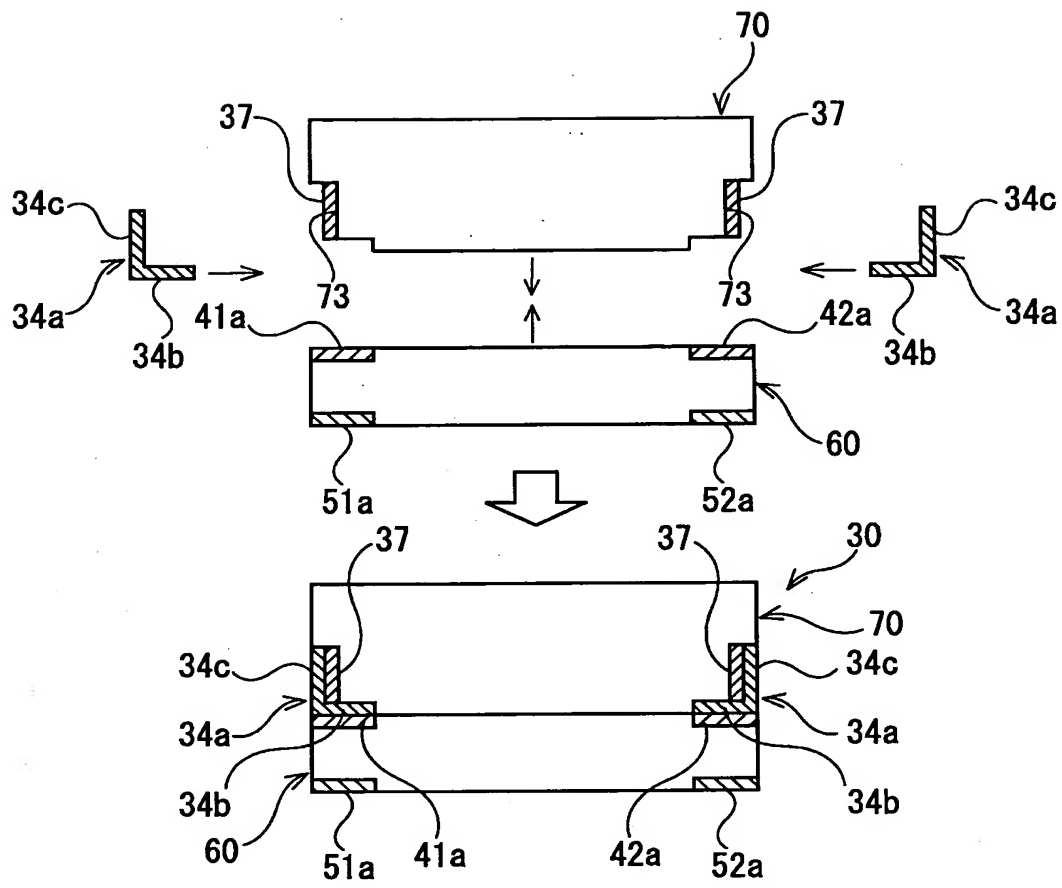


FIG. 12

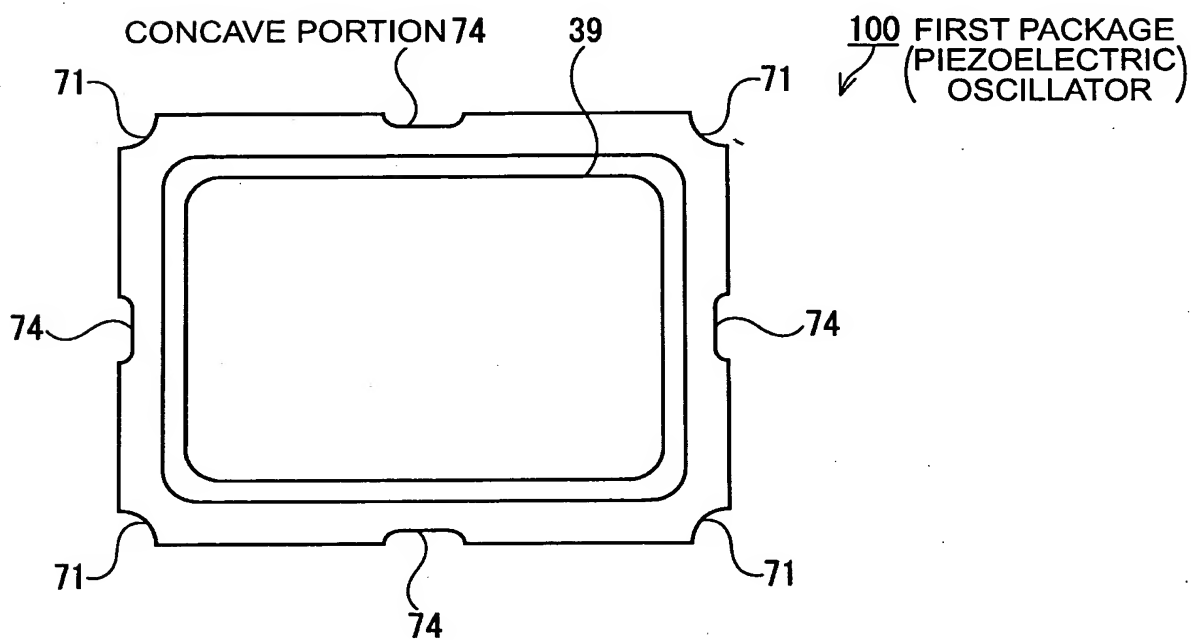
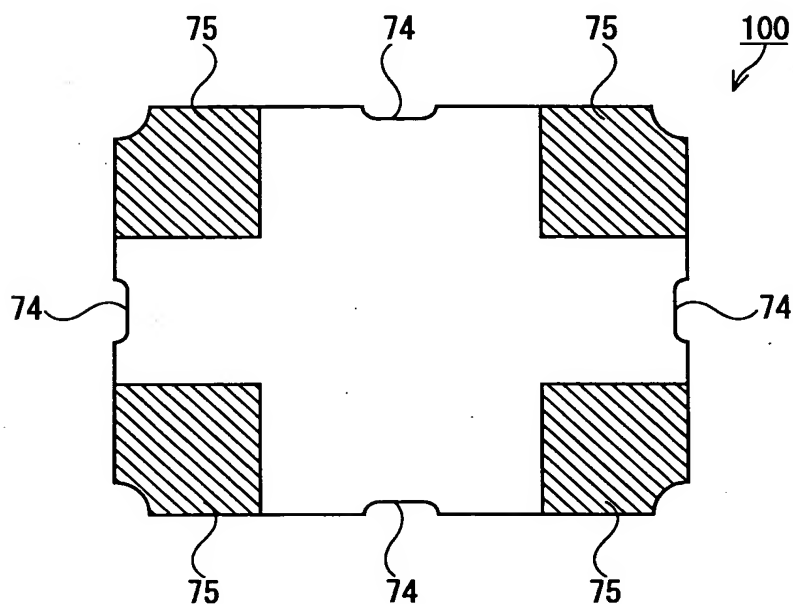
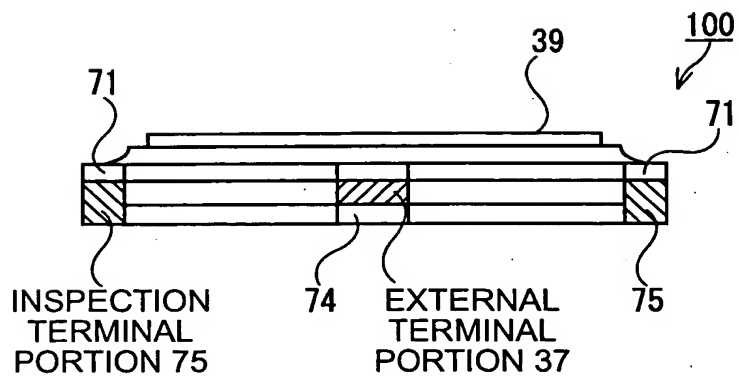


FIG. 13

FIG. 15



110 FIRST PACKAGE

31, 32, 33, 36, 37, 38, 39, 70a, 70b, 70c, 76

CONDUCTIVE PATTERN 76a

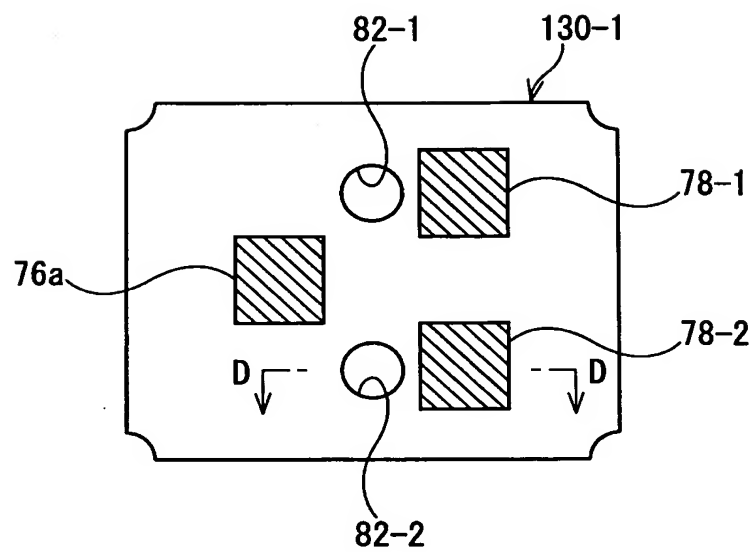


FIG. 19

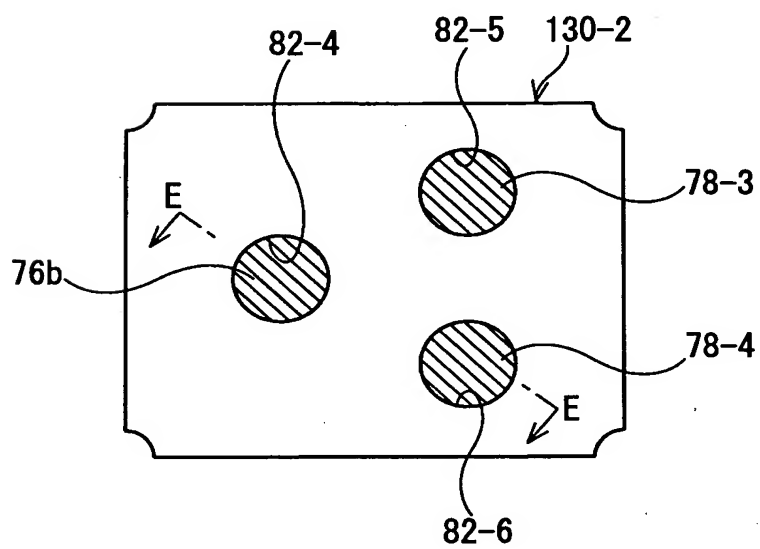


FIG. 20

FIG. 21

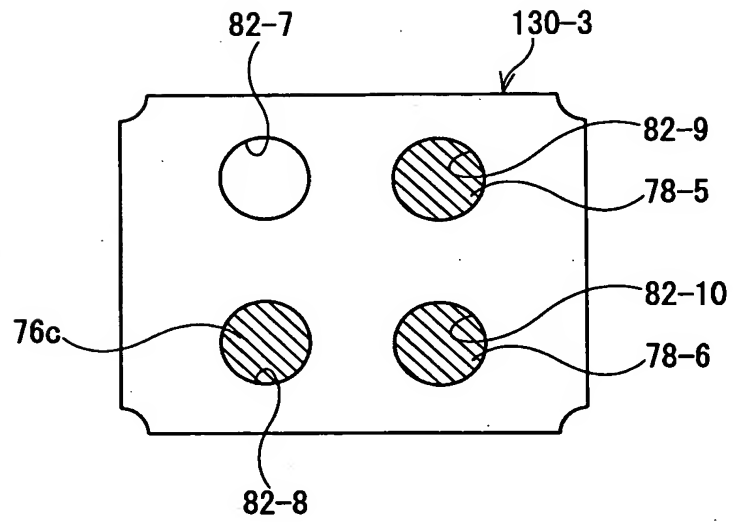


FIG. 22

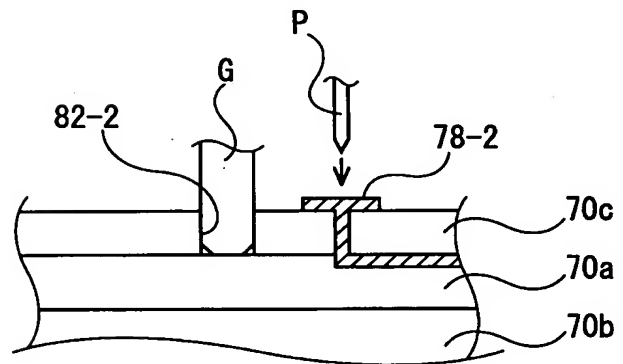
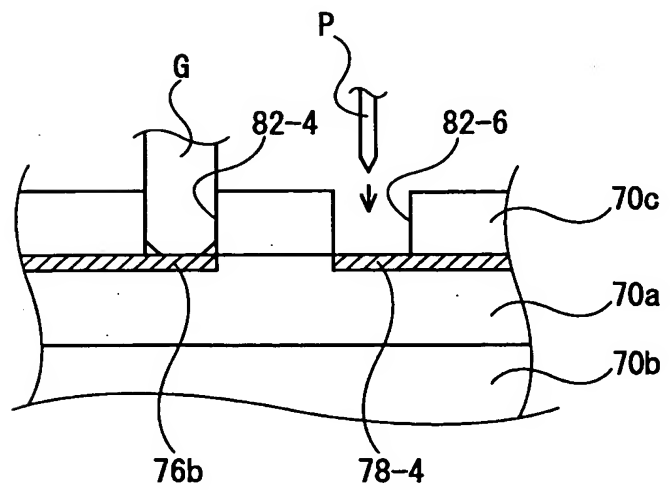


FIG. 23



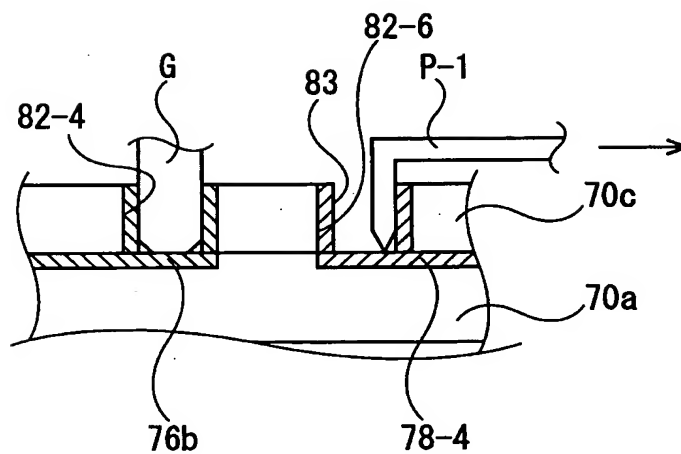


FIG. 24

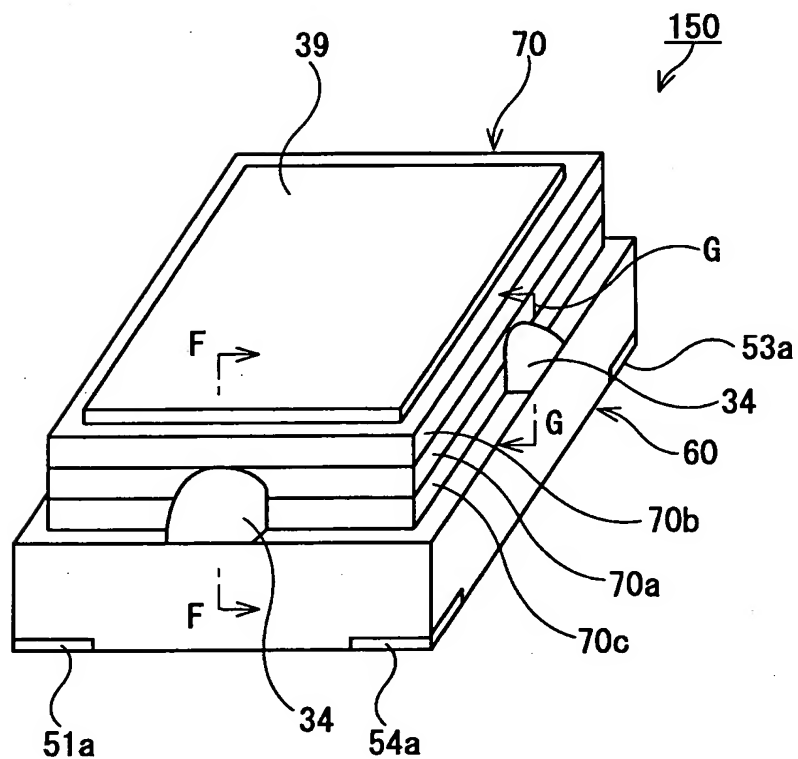


FIG. 25

FIG. 26

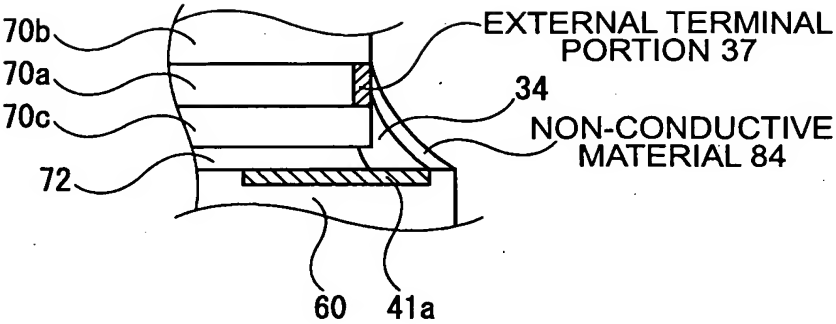


FIG. 27

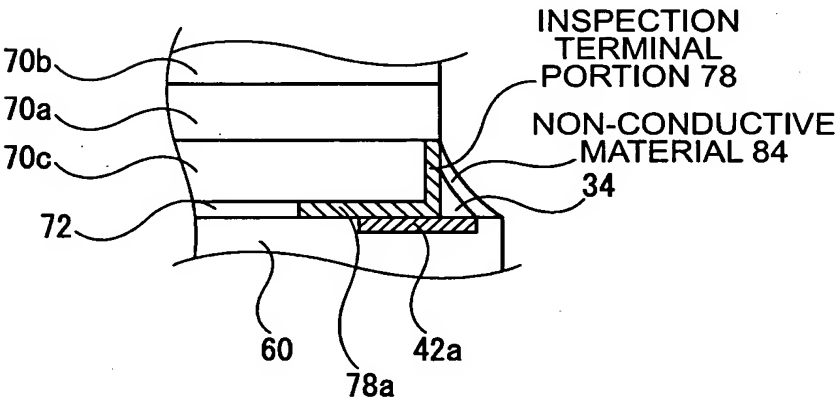
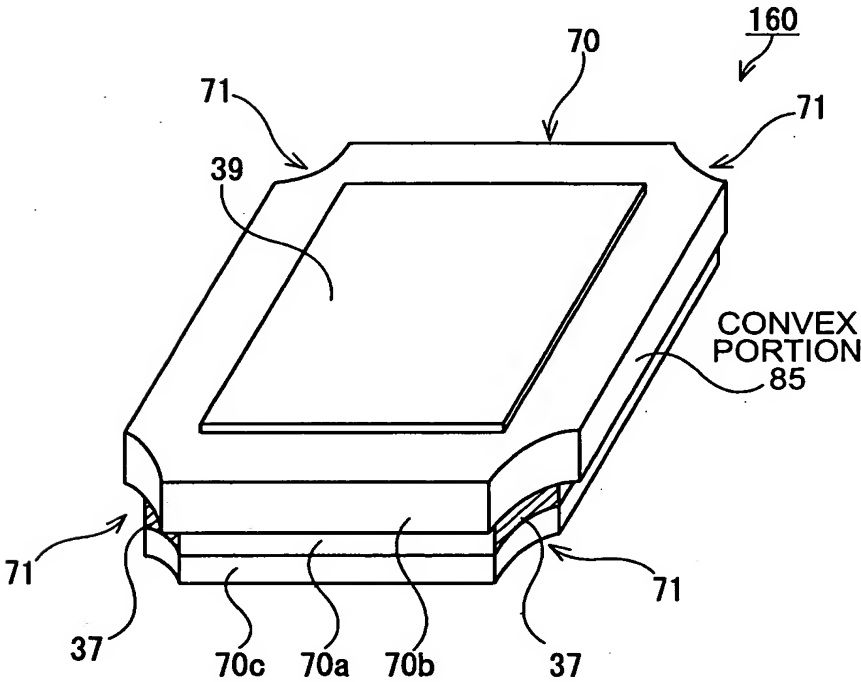


FIG. 28



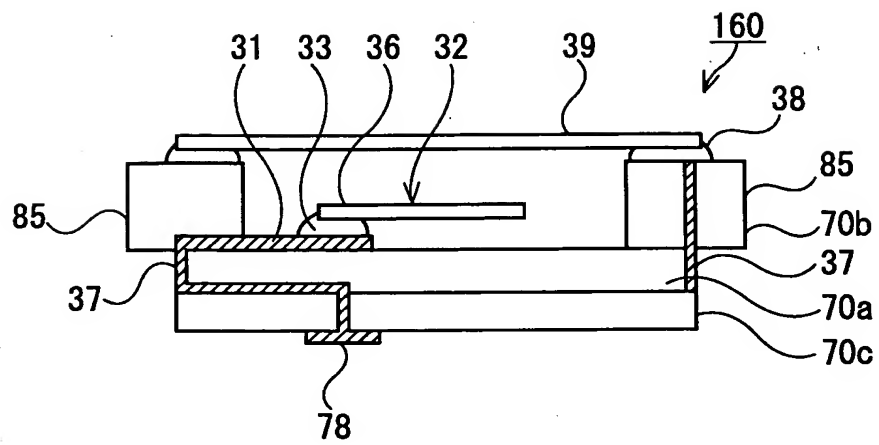


FIG. 29

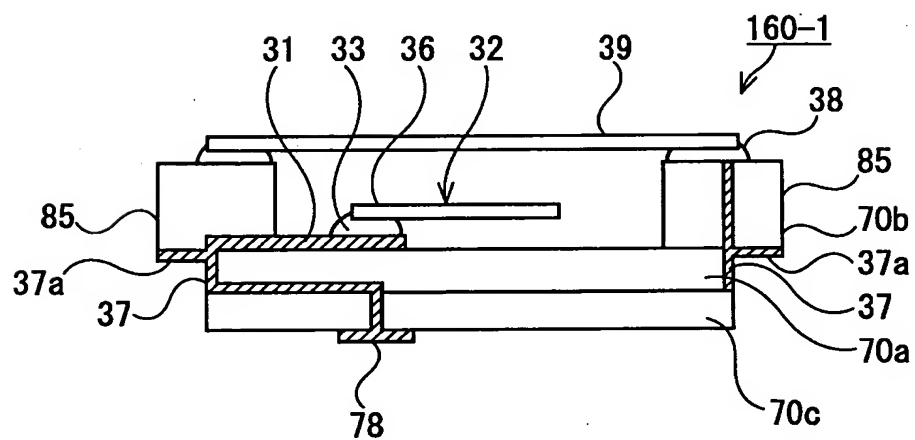


FIG. 30

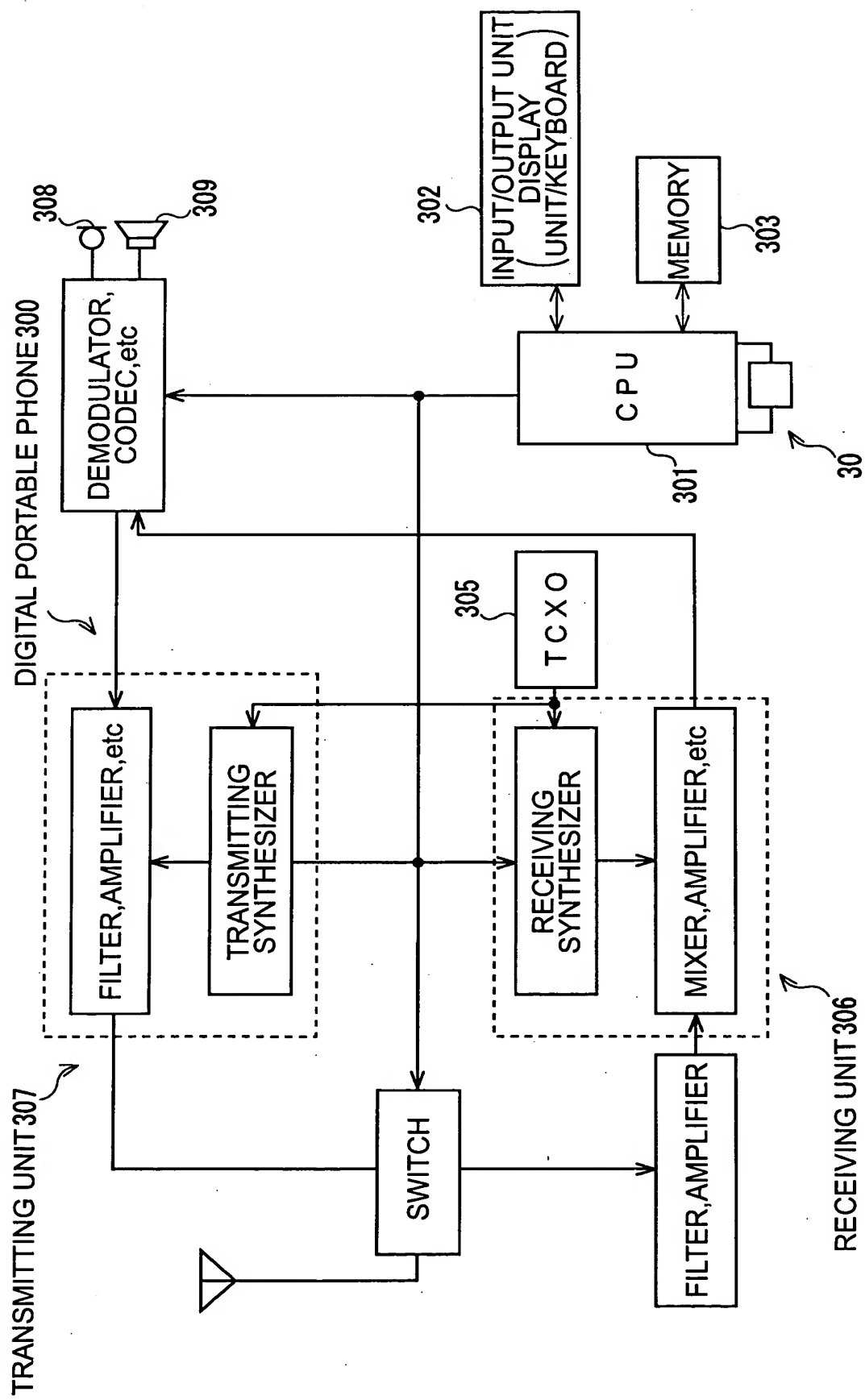


FIG. 31

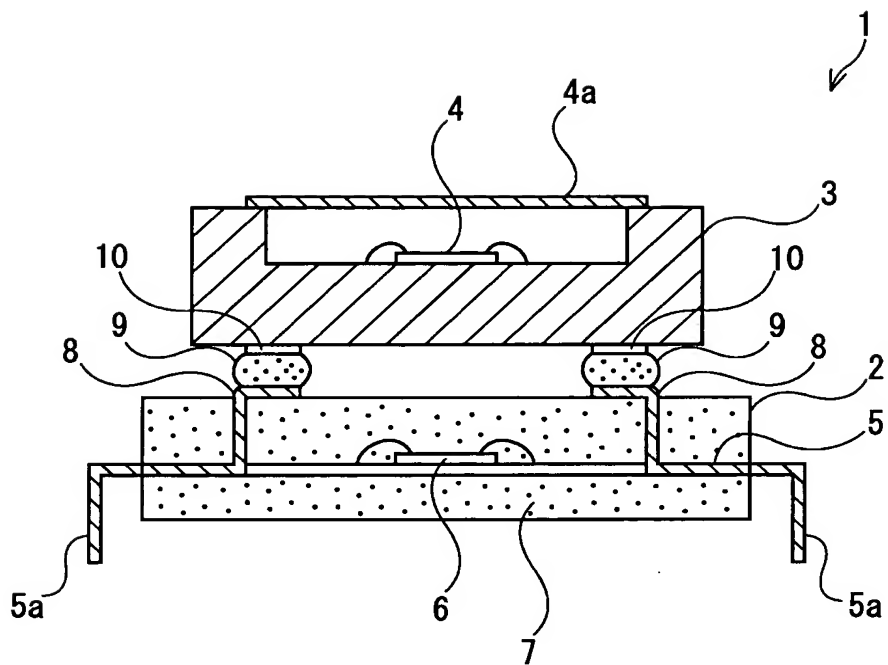


FIG. 32